ASSOCIATION CONNECTING ASSOCIATION CONNECTING ELECTRONICS INDUSTRIES® international and Par	PC. Bannockl	burn, Illinois, A	ll rights reserved untions.	under both	This docum level parts, t	ent is a declarati he declaration e	on of the su	ibstances v s all lower	within the manufactu level materials for v	urer listed which the	item. Note: manufacture	if the item is an as er has engineering	sembly with low responsibility.	
IPC Web Site for Information on IPC-1752 Standard Form				Form Type Distribute	* Declaration Class * Class 6 - RoHS Yes/No, Homogeneous Mater					rials and N	als and Mfg Information			
Supplier Information														
Company name* Com			Company unique ID			Unique ID Authority				Respon	Response Date*			
onsemi								2024-04-24						
Dontact Name Title - Contact			et		Phone - Contact*				Email - Contact*					
Product-Env-Stewards Product Enviro			iro Compliance		NA				Produ	Product-Env-Stewards@onsemi.com				
Authorized Representative* Title - Repre			esentative			Phone - Representative*				Email	Email - Representative*			
Product-Env-Stewards Produ			Product Enviro Compliance			NA				Produ	Product-Env-Stewards@onsemi.com			
Requester Item Number	ster Item Number Mfr Item Nu		Number Mfr Item Name			Effective Date	Version	ersion Manufacturing Site			Weight*	UOM	Unit Type	
	NSS406	NSS40600CF8T1G LOW VCES 40V		PNP CHIPFET		2024-04-24		M	MY1		11.78	mg	Each	
Ianufacturing Proccess Informa	tion						-				-			
Terminal Plating / Grid Array M	aterial	rial Terminal Base Alloy		J-STD-020 MSI	SL Rating Peak		k Process Body Temperature Max Time at Peak		k Tempera	ature Num	ber of Reflow Cyc	eles		
Matte Tin (Sn) - annealed CU Alloy		CU Alloy		1		260		С	30	seco	nds 3			
omments														
vel 1 - maximum time at peak temperat	ure during so	dering is 10-3	0 seconds											
or more information regarding material	composition	please refer to	page 3											

RoHS Material Composition Declaration				Declaration Type *	Detailed						
Directive 2015/863/EU amending RoHS Directive 2011/65/EU	RoHS Definition: Quantity limit of 0.01% by mass (100 PPM) in homogeneous material for Cadmium and quantity limit of 0.1% by mass (1000 PPM) in homogeneous material for: Lead (Pb), Mercury (Hg), Hexavalent Chromium (Cr6+), Polybrominated Biphenyls (PBB), Polybrominated Diphenyl Ethers (PBDE), and Bis(2-ethylhexyl) phthalate (DEHP), Benzyl-butyl phthalate (BBP), Dibutyl phthalate (DBP), Disobutyl phthalate (DIBP).										
cadmium, hexavalentchromium, polybrominate contains a RoHS restricted substance inexcess encompass all such components. Supplier certif as of the date that Supplier completes this form Company acknowledges that Supplier may hav independently verified information provided by certification in this paragraph. If the Company a	ed biphenyls and/or polybrominated dip of an applicable quantity limit, please ir ies that it gathered the information it pro- .Supplier acknowledges that Company e relied on informationprovided by othe v others, Supplier agrees that, at a minin and the Supplier enter into a written agre pource of the Supplier's liability and the	henyl ethers (each a " ndicate below which, i ovides in this form us will rely on this certifiers in completing this num, itssuppliers have eement with respect to Company's remedies	RoHS restricted substance") in exce if any, RoHS exemption you believe ing appropriate methods to ensure if ication in determining the complian form, and that Supplier may not have e provided certifications regarding the to the identified part, the terms and co for issues that arise regarding inform	ce of its products with European Union membe	ove. If a homogeneous material within the part er level components, the declaration shall l correct to the best of its knowledge and belief, r state laws that implement the RoHS Directive. wever, in situations where Supplier has not tions are at least as comprehensive as the anty rights and/or remedies provided as part of						
RoHS Declaration * 1 - Item(s)	does not contain RoHS restricted substa	on above	Supplier Acceptance	* Accepted							
Exemption: If the declared item does not con applicable exemptions.	ntain RoHS restricted substances per	the definition above	except for defined RoHS exempti	ons, then select the corresponding response i	n the RoHS Declaration above and choose all						
Exemption List Version	EL-2011/534/EU										
Declaration Signature											
Instructions: Complete all of the required fin Requester) and click on Submit Form to have	elds on all pages of this form. Select the form returned to the Requester	he "Accepted" on th	e Supplier Acceptance drop-down	. This will display the signature area. Digital	lly sign the declaration (if required by the						
Supplier Digital Signature Ra	stislav Drska	Le									

## Homogeneous Material Composition Declaration for Electronic Products

SubItem Instructions: The presence of any JIG Level A or B substances must be declared. [1] indicate the subpart in which the substance is located, [2] provide a description of the homogeneous material [3], enter the weight of the homogeneous material.

	cable [E] enter the weigh			ance category (JIG or Requester) or enter a [F] Optionally enter the positive (+) and n				
Homogeneous Material	Weight	Unit of Measure	Level	Substance	CAS	Exempt	Weight	Unit of Measure
Die	1.05	mg	Supplier	Silicon (Si)	7440-21-3		1.05	mg
Die Attach	0.31	mg	Supplier	Silver (Ag)	7440-22-4		0.2325	mg
			Supplier	Epoxy resins	129915-35-1		0.0775	mg
Lead Frame	4.67	mg	Supplier	Silver (Ag)	7440-22-4		0.0374	mg
			Supplier	Zinc (Zn)	7440-66-6		0.0047	mg
			Supplier	Iron (Fe)	7439-89-6		0.1214	mg
			Supplier	Copper (Cu)	7440-50-8		4.5065	mg
Mold Compound-Black	5.38	mg		Epoxy resin	proprietary data		0.269	mg
			Supplier	Phenolic Resin	Proprietary Data		0.269	mg
			Supplier	Ortho Cresol Novolac Resin	29690-82-2		0.1076	mg
			Supplier	Carbon Black (C)	1333-86-4		0.0269	mg
			Supplier	Fused Silica (SiO2)	60676-86-0		4.7075	mg
Plating	0.25	mg	Supplier	Tin (Sn)	7440-31-5		0.25	mg
Wire Bond - Cu	0.12	mg	Supplier	Copper (Cu)	7440-50-8		0.12	mg